

R1180x SERIES

150mA LDO REGULATOR

NO.EA-105-220531

OUTLINE

The R1180x Series are CMOS-based voltage regulator ICs with high output voltage accuracy, extremely low supply current, and low ON-resistance. Each of these ICs consists of a voltage reference unit, an error amplifier, resistor-net for voltage setting, a current limit circuit which prevents the destruction by excess current, and so on. The output voltage of these ICs is fixed with high accuracy. B version has a chip enable pin, therefore ultra-low consumption current standby mode can be realized with the pin.

Since the packages for these ICs are SOT-23-5 (R1180N Series), SC-82AB (R1180Q Series), and SON1612-6 (R1180D Series), therefore high density mounting of the ICs on boards is possible.

FEATURES

Typ. 1μA
(Except the current through CE pull-down circuit)
Typ. 0.1μA
Typ. 0.25V (Iout=150mA 3.0V Output type)
Typ. ±100ppm/°C
Typ. 0.05%/V
±2.0%
SON1612-6, SC-82AB, SOT-23-5
1.2V to 3.6V (0.1V steps)
(For other voltages, please refer to MARK INFORMATIONS.)
Typ. 40mA (Current at short mode)

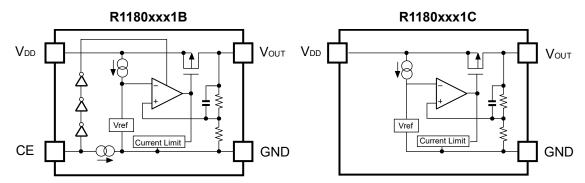
APPLICATIONS

- Stable voltage reference.
- Power source for electrical appliances such as cameras, VCRs and camcorders.

• Ceramic capacitors are recommended to be used with this IC0.1 μF

• Power source for battery-powered equipment.

BLOCK DIAGRAMS



SELECTION GUIDE

The output voltage, CE pin polarity, package, etc. for the ICs can be selected at the user's request.

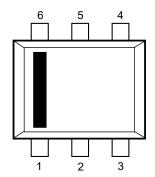
Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R1180Dxx1*-TR-FE	SON1612-6	4,000 pcs	Yes	Yes
R1180Qxx1*-TR-FE	SC-82AB	3,000 pcs	Yes	Yes
R1180Nxx1*-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes

xx: The output voltage can be designated in the range from 1.2V(12) to 3.6V(36) in 0.1V steps. (For other voltages, please refer to MARK INFORMATIONS.)

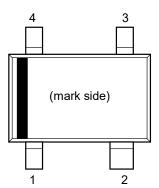
- * : CE pin polarity are options as follows.
 - (B) "H" Active
 - (C) without CE pin

PIN CONFIGURATION

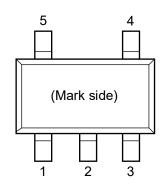
• SON1612-6







● SOT-23-5



PIN DESCRIPTIONS

• SON1612-6

Pin No	Symbol	Pin Description
1	V _{DD}	Input Pin
2	GND	Ground Pin
3	Vоит	Output pin
4	NC	No Connection
5	GND	Ground Pin
6	CE or NC	Chip Enable Pin or No Connection

• SC-82AB

Pin No	Symbol	Pin Description
1	CE or NC	Chip Enable Pin or No Connection
2	GND	Ground Pin
3	Vоит	Output pin
4	V _{DD}	Input Pin

• SOT-23-5

Pin No	Symbol	Pin Description
1	V_{DD}	Input Pin
2	GND	Ground Pin
3	CE or NC	Chip Enable Pin or No Connection
4	NC	No Connection
5	Vоит	Output pin

ABSOLUTE MAXIMUM RATINGS

Symbol	Item	Rating	Unit
VIN	Input Voltage	6.5	V
Vce	Input Voltage (CE Pin)	6.5	V
Vоит	Output Voltage	−0.3 to V _{IN} +0.3	V
Іоит	Output Current	180	mA
	Power Dissipation (SON1612-6)*	500	
P _D Power Dissipation (SC-82AB)* 3		380	mW
	Power Dissipation (SOT-23-5)*	420	
Topt	Operating Temperature Range	-40 to 85	°C
Tstg	Storage Temperature Range	-55 to 125	°C

^{*)} For Power Dissipation, please refer to PACKAGE INFORMATION.

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field.

The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

ELECTRICAL CHARACTERISTICS

• R1180xxx1B/C

Topt=25°C

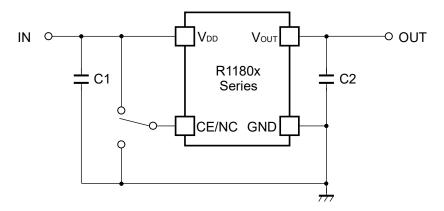
Symbol	Item	Conditions	Min.	Тур.	Max.	Unit
Vоит	Output Voltage	V _{IN} =Set V _{OUT} +1V 1μA ≤ I _{OUT} ≤ 30mA	×0.980		×1.020	٧
Іоит	Output Current	V _{IN} -V _{OUT} =1.0V(V _{OUT} ≥ 1.4V) V _{IN} =2.4V(V _{OUT} <1.4V)	150			mA
ΔVουτ/ΔΙουτ	Load Regulation	$V_{\text{IN}}-V_{\text{OUT}}=1.0V(V_{\text{OUT}}\geq 1.4V)$ $V_{\text{IN}}=2.4V(V_{\text{OUT}}<1.4V)$ $1\mu\text{A}\leq \text{Iout}\leq 150\text{mA}$		20	40	mV
V _{DIF}	Dropout Voltage	Refer to the ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE			TUT	
Iss	Supply Current	VIN-VOUT=1.0V,IOUT=0mA		1.0	1.5	μΑ
Istandby	Supply Current (Standby)	VIN-VOUT=1.0V,VCE=GND		0.1	1.0	μΑ
ΔVout/ΔVin	Line Regulation	Iout=30mA Vout + 0.5V ≤ Vin ≤ 6.0V (Vout ≥ 1.5V) $2.0V \le Vin \le 6.0V$ $(1.2V \le Vout \le 1.4V)$		0.05	0.20	%/V
Vin	Input Voltage		1.7		6.0	V
ΔVουτ/ ΔTopt	Output Voltage Temperature Coefficient	I _{OUT} =30mA -40°C ≤ Topt ≤ 85°C		±100		ppm /°C
Isc	Short Current Limit	Vout=0V		40		mA
lpd	CE Pull-down Constant Current	(R1180xxx1B)		0.35		μΑ
Vceh	CE Input Voltage "H"	(R1180xxx1B)	1.2		6.0	V
Vcel	CE Input Voltage "L"	(R1180xxx1B)	0.0		0.3	V

• ELECTRICAL CHARACTERISTICS by OUTPUT VOLTAGE

 $Topt = 25^{\circ}C$

Output Voltage	Dropout Voltage V _{DIF} (V)		
V оит (V)	V _{ουτ} (V) Condition		Max.
1.2 ≦ V _{OUT} < 1.3		0.85	1.20
1.3 ≦ V _{О∪Т} < 1.4		0.75	1.10
1.4 ≤ V _{OUT} < 1.5	Iouт=150mA	0.65	1.00
1.5 ≦ Vouт < 1.7		0.60	0.90
1.7 ≦ V _{OUT} < 1.9		0.50	0.75
1.9 ≦ V _{OUT} < 2.1		0.40	0.65
2.1 ≤ V _{OUT} < 2.8		0.35	0.55
$2.8 \leq V_{\text{OUT}} \leq 3.6$		0.25	0.40

TYPICAL APPLICATION



(External Components)
Output Capacitor

Ceramic Capacitor 0.1µF

TECHNICAL NOTES

When using these ICs, consider the following points:

Phase Compensation

In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, use a capacitor C2 with good frequency characteristics and ESR (Equivalent Series Resistance). (Note: If additional ceramic capacitors are connected with parallel to the output pin with an output capacitor for phase compensation, the operation might be unstable. Because of this, test these ICs with as same external components as ones to be used on the PCB.)

PCB Layout

Make V_{DD} and GND lines sufficient. If their impedance is high, noise pickup or unstable operation may result. Connect a capacitor C1 with a capacitance value as much as $0.1\mu F$ or more between V_{DD} and GND pin, and as close as possible to the pins.

Set external components, especially the output capacitor C2, as close as possible to the ICs, and make wiring as short as possible.

PACKAGE INFORMATION

POWER DISSIPATION (SON1612-6)

Power Dissipation (PD) depends on conditions of mounting on board.

This specification is based on the measurement at the condition below:

* Measurement Conditions

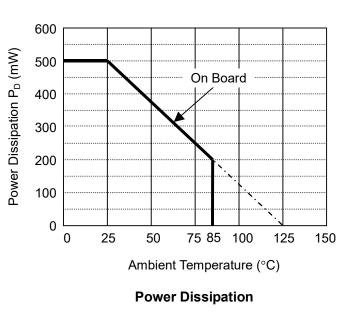
	Standard Land Pattern		
Environment	Mounting on Board (Wind velocity 0m/s)		
Board Material	Glass cloth epoxy plastic (Double layers)		
Board Dimensions	40mm × 40mm × 1.6mm		
Copper Ratio	Top side: Approx. 50%, Back side: Approx. 50%		
Through - hole	φ 0.5mm × 24pcs		

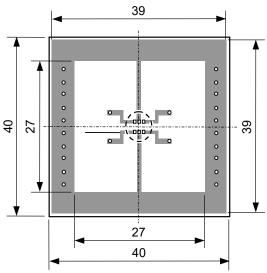
* Measurement Results (Ta=25°C, Tjmax=125°C)

Standard Land Pattern

Power Dissipation 500mW

Thermal Resistance θja = (125-25°C)/ 0.5W = 200°C/W

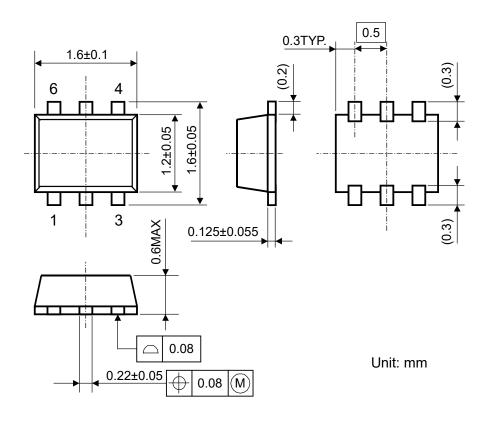




Measurement Board Pattern

() IC Mount Area (Unit: mm)

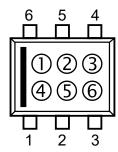
PACKAGE DIMENSIONS (SON1612-6)



MARK SPECIFICATION (SON1612-6)

①②③④: Product Code ... Refer to R1180D Series Mark Specification Table

⑤⑥: Lot Number ... Alphanumeric Serial Number



R1180D MARK SPECIFICATION TABLE (SON1612-6)

R1180Dxx1B Series

R1180Dxx1C Series

Product Name	1234	Product Name	1234
R1180D121B	G12B	R1180D121C	G12C
R1180D131B	G13B	R1180D131C	G13C
R1180D141B	G14B	R1180D141C	G14C
R1180D151B	G15B	R1180D151C	G15C
R1180D161B	G16B	R1180D161C	G16C
R1180D171B	G17B	R1180D171C	G17C
R1180D181B	G18B	R1180D181C	G18C
R1180D191B	G19B	R1180D191C	G19C
R1180D201B	G20B	R1180D201C	G20C
R1180D211B	G21B	R1180D211C	G21C
R1180D221B	G22B	R1180D221C	G22C
R1180D231B	G23B	R1180D231C	G23C
R1180D241B	G24B	R1180D241C	G24C
R1180D251B	G25B	R1180D251C	G25C
R1180D261B	G26B	R1180D261C	G26C
R1180D271B	G27B	R1180D271C	G27C
R1180D281B	G28B	R1180D281C	G28C
R1180D291B	G29B	R1180D291C	G29C
R1180D301B	G30B	R1180D301C	G30C
R1180D311B	G31B	R1180D311C	G31C
R1180D321B	G32B	R1180D321C	G32C
R1180D331B	G33B	R1180D331C	G33C
R1180D341B	G34B	R1180D341C	G34C
R1180D351B	G35B	R1180D351C	G35C
R1180D361B	G36B	R1180D361C	G36C
R1180D181B5	G00B	R1180D181C5	G00C
R1180D261B5	G01B	R1180D261C5	G01C

POWER DISSIPATION (SC-82AB)

Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the Measurement Conditions below.

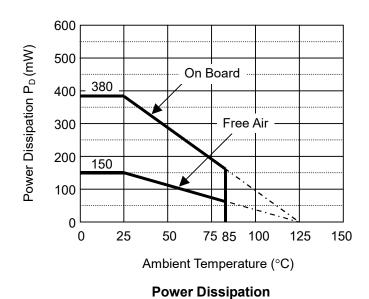
Measurement Conditions

	Standard Land Pattern
Environment	Mounting on Board (Wind Velocity=0m/s)
Board Material	Glass Cloth Epoxy Plastic (Double-layers)
Board Dimensions	40mm × 40mm × 1.6mm
Copper Ratio	Topside: Approx. 50%, Backside: Approx. 50%
Through-hole	φ0.5mm × 44pcs

Measurement Result

(Ta=25°C, Tjmax=125°C)

		(, -, -,
	Standard Land Pattern	Free Air
Power Dissipation	380mW	150mW
Thermal Resistance	θja = (125-25°C)/0.38W = 263°C/W	667°C/W

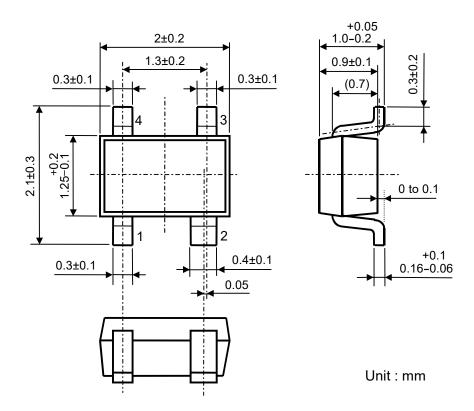


40

Measurement Board Pattern

IC Mount Area (Unit : mm)

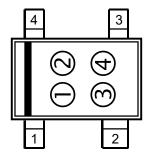
PACKAGE DIMENSIONS (SC-82AB)



MARK SPECIFICATION (SC-82AB)

 $\textcircled{1} \textcircled{2} \text{: Product Code} \dots \underline{\textbf{Refer to R1180Q Series Mark Specification Table} }$

③④: Lot Number ... Alphanumeric Serial Number



R1180Q MARK SPECIFICATION TABLE (SC-82AB)

R1180Qxx1B Series

R1180Qxx1C Series

Product Name	12	
R1180Q121B	A2	
R1180Q131B	A3	
R1180Q141B	A 4	
R1180Q151B	A5	
R1180Q161B	A6	
R1180Q171B	A7	
R1180Q181B	80Q181B A8	
R1180Q191B	A9	
R1180Q201B	В0	
R1180Q211B	B1	
R1180Q221B	B2	
R1180Q231B	В3	
R1180Q241B	B4	
R1180Q251B	B5	
R1180Q261B	В6	
R1180Q271B	B7	
R1180Q281B	B8	
R1180Q291B	В9	
R1180Q301B	C0	
R1180Q311B	C1	
R1180Q321B	C2	
R1180Q331B	С3	
R1180Q341B	C4	
R1180Q351B	C5	
R1180Q361B	C6	
R1180Q181B5	C 7	
R1180Q261B5	C8	

Product Name	12	
R1180Q121C	D2	
R1180Q131C	D3	
R1180Q141C	D4	
R1180Q151C	D5	
R1180Q161C	D6	
R1180Q171C	D7	
R1180Q181C	180Q181C D8	
R1180Q191C	D9	
R1180Q201C	E0	
R1180Q211C	Q211C E1	
R1180Q221C	E2	
R1180Q231C	E3	
R1180Q241C	E4	
R1180Q251C	E5	
R1180Q261C	E6	
R1180Q271C	E7	
R1180Q281C	E8	
R1180Q291C	E9	
R1180Q301C	F0	
R1180Q311C	F1	
R1180Q321C	F2	
R1180Q331C	F3	
R1180Q341C	F4	
R1180Q351C	F5	
R1180Q361C	F6	
R1180Q181C5	F7	
R1180Q261C5	F8	

POWER DISSIPATION (SOT-23-5)

Power Dissipation (P_D) depends on conditions of mounting on board. This specification is based on the measurement at the condition below:

(Power Dissipation (SOT-23-5) is substitution of SOT-23-6.)

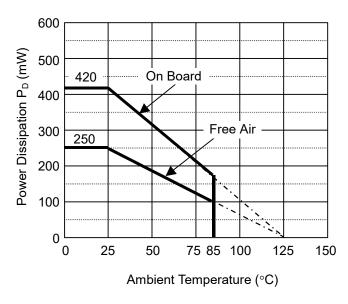
* Measurement Conditions

	Standard Test Land Pattern	
Environment	Mounting on Board (Wind velocity=0m/s)	
Board Material	Glass cloth epoxy plastic (Double sided)	
Board Dimensions	40mm*40mm*1.6mm	
Copper Ratio	Top side: Approx. 50%, Back side: Approx. 50%	
Through-holes	φ 0.5mm * 44pcs	

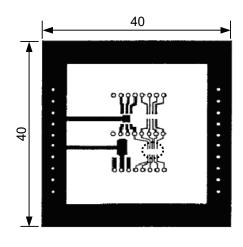
* Measurement Result:

(Ta=25°C, Tjmax=125°C)

	Standard Land Pattern	Free Air
Power Dissipation	420mW	250mW
Thermal Resistance	θja = (125-25°C)/0.42W= 238°C/W	400°C/W



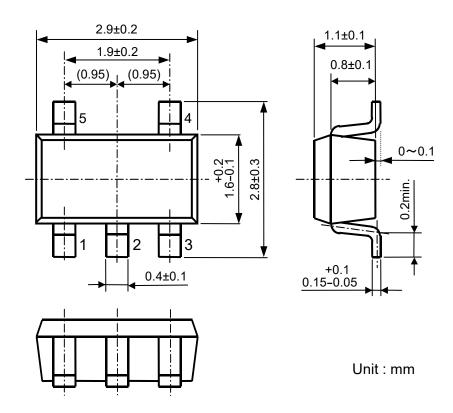
Power Dissipation



Measurement Board Pattern

IC Mount Area (Unit: mm)

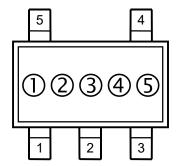
PACKAGE DIMENSIONS (SOT-23-5)



MARK SPECIFICATION (SOT-23-5)

①②③: Product Code ... Refer to R1180N Series Mark Specification Table

④⑤: Lot Number ... Alphanumeric Serial Number



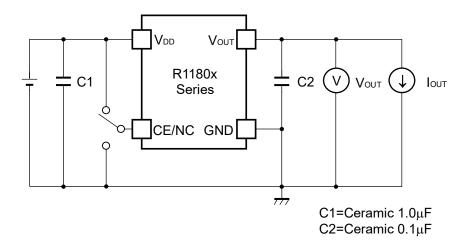
R1180N MARK SPECIFICATION TABLE (SOT-23-5)

R1180Nxx1B Series

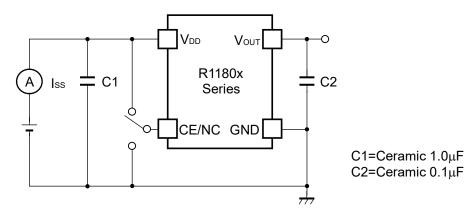
R1180Nxx1C Series

KTTOOTKAXTB OCTIOS	KITOONAATO GETICS		
Product Name	123	Product Name	123
R1180N121B	C12	R1180N121C	D12
R1180N131B	C13	R1180N131C	D13
R1180N141B	C14	R1180N141C	D14
R1180N151B	C15	R1180N151C	D15
R1180N161B	C16	R1180N161C	D16
R1180N171B	C17	R1180N171C	D17
R1180N181B	C18	R1180N181C	D18
R1180N191B	C19	R1180N191C	D19
R1180N201B	C20	R1180N201C	D20
R1180N211B	C21	R1180N211C	D21
R1180N221B	C22	R1180N221C	D22
R1180N231B	C23	R1180N231C	D23
R1180N241B	C24	R1180N241C	D24
R1180N251B	C25	R1180N251C	D25
R1180N261B	C26	R1180N261C	D26
R1180N271B	C27	R1180N271C	D27
R1180N281B	C28	R1180N281C	D28
R1180N291B	C29	R1180N291C	D29
R1180N301B	C30	R1180N301C	D30
R1180N311B	C31	R1180N311C	D31
R1180N321B	C32	R1180N321C	D32
R1180N331B	C33	R1180N331C	D33
R1180N341B	C34	R1180N341C	D34
R1180N351B	C35	R1180N351C	D35
R1180N361B	C36	R1180N361C	D36
R1180N181B5	C37	R1180N181C5	D37
R1180N261B5	C38	R1180N261C5	D38

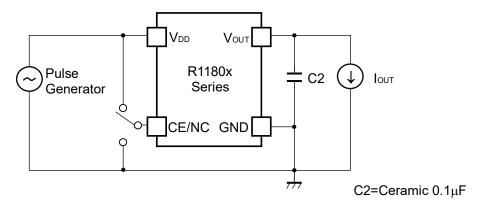
TEST CIRCUITS



Standard test Circuit



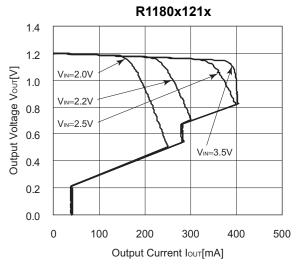
Supply Current Test Circuit

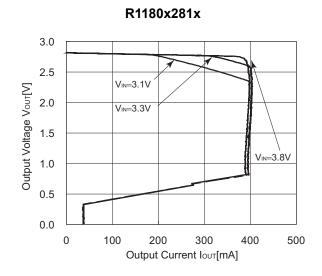


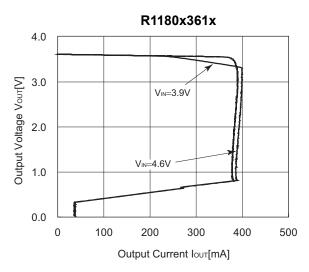
Ripple Rejection, Line Transient Response Test Circuit

TYPICAL CHARACTERISTICS

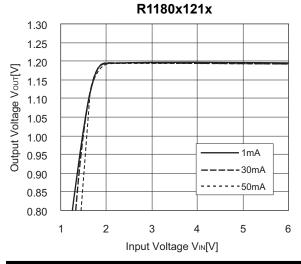
1) Output Voltage vs. Output Current (Topt=25°C)

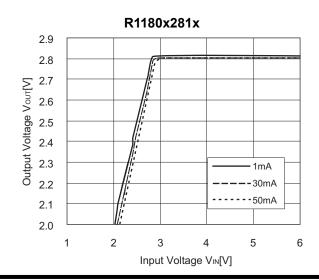


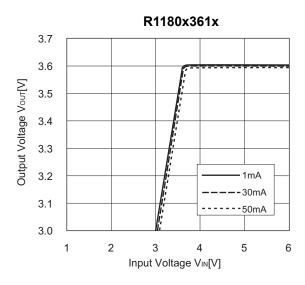




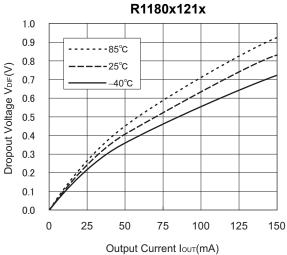
2) Output Voltage vs. Input Voltage (Topt=25°C)

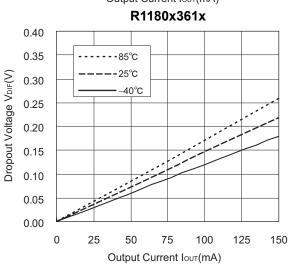


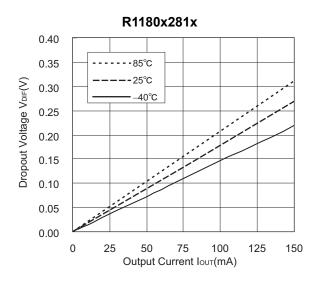




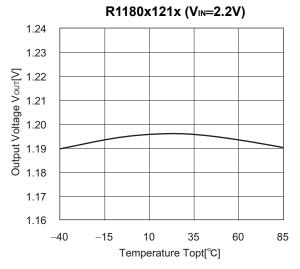
3) Dropout Voltage vs. Output Current

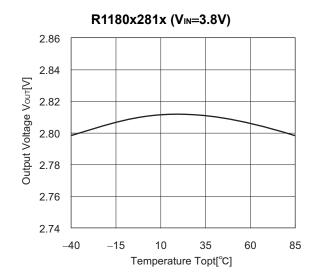


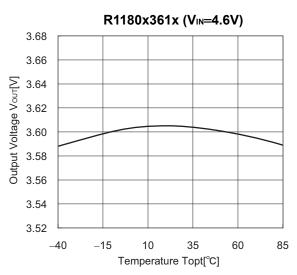




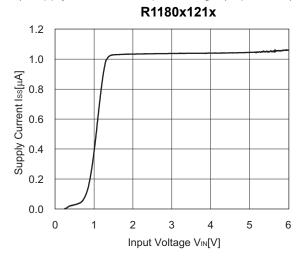
4) Output Voltage vs. Temperature (Iout=30mA)

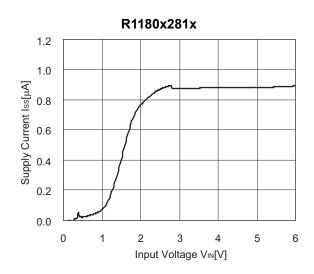




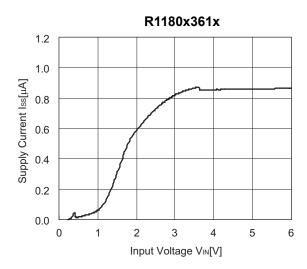


5) Supply Current vs. Input Voltage (Topt=25°C)

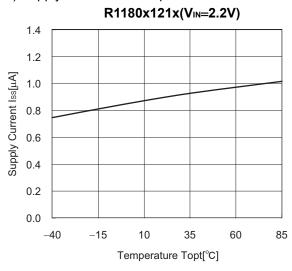


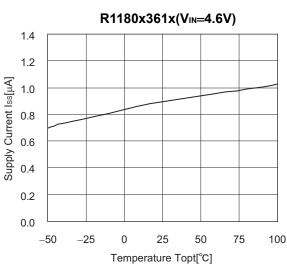


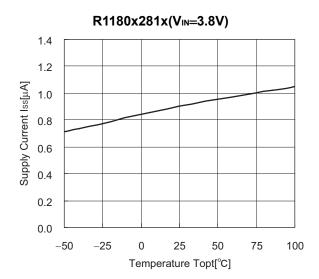
NO.EA-105-220531



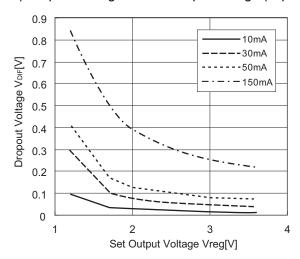
6) Supply Current vs. Temperature



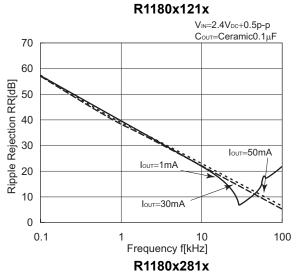


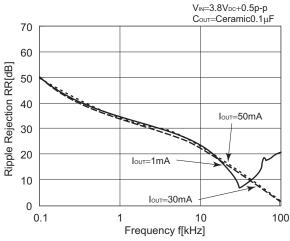


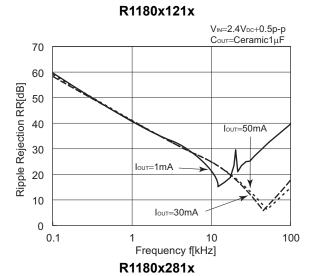
7) Dropout Voltage vs. Set Output Voltage (Topt=25°C)

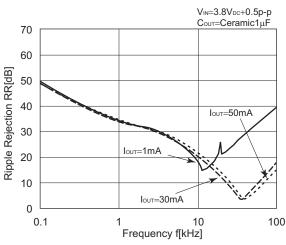


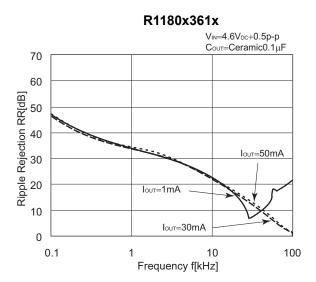
8) Ripple Rejection vs. Frequency (C_{IN}=none)





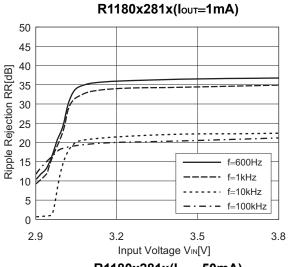


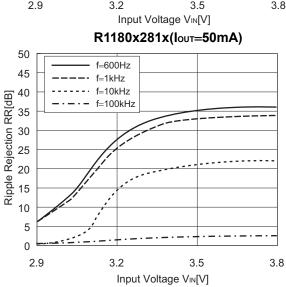


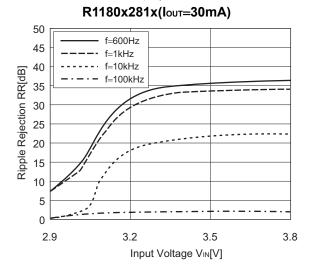


R1180x361x VIN=4.6VDC+0.5p-p C_{OUT}=Ceramic1μF 70 60 Ripple Rejection RR[dB] 50 40 Іоит=50mA 30 20 10 0 0.1 100 Frequency f[kHz]

9) Ripple Rejection vs. Input Bias Voltage (Topt=25°C, C_{IN}=none, C_{OUT}=Ceramic0.1μF)

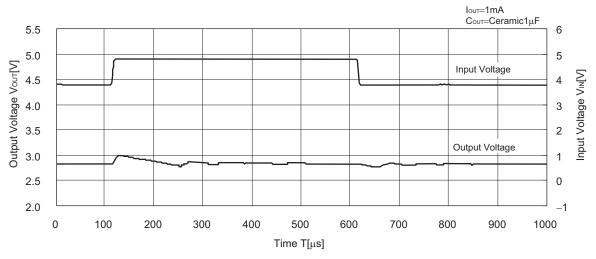




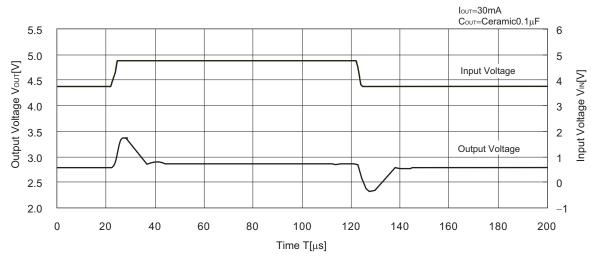


10) Input Transient Response (C_{IN}=none, tr=tf=5μs)

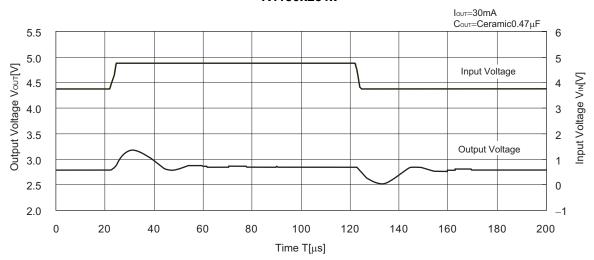


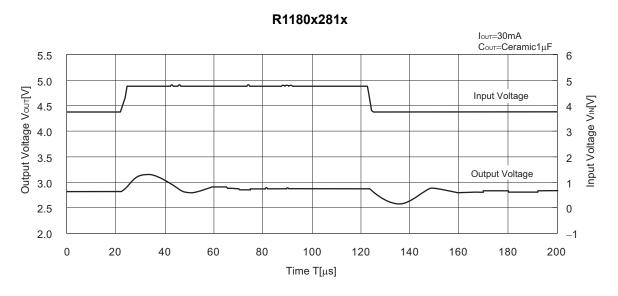


R1180x281x

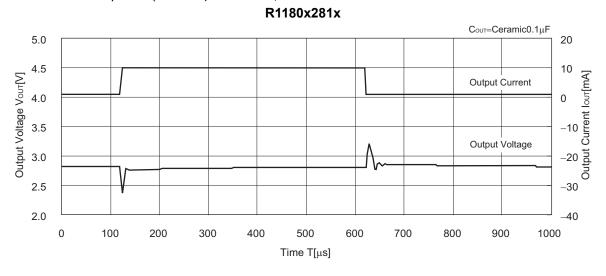


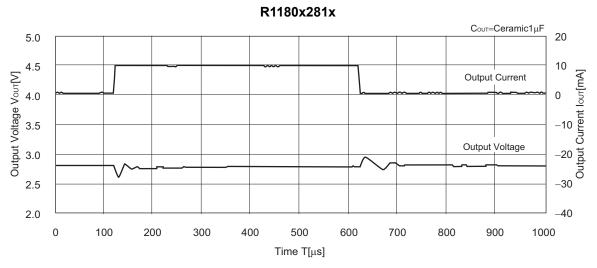
R1180x281x

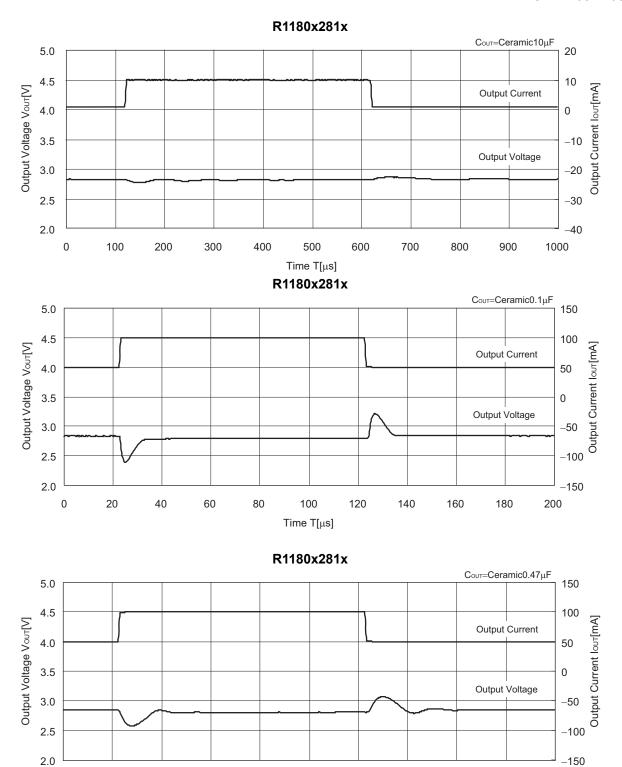




11) Load Transient Response (tr=tf=0.5μs V_{IN}=3.8V)

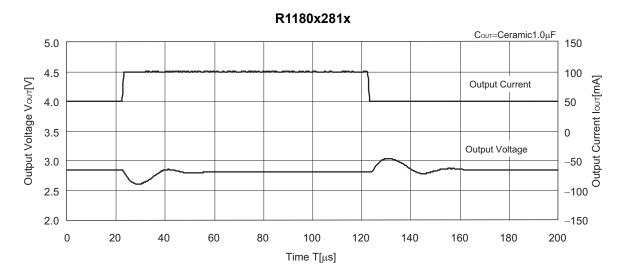






Time $T[\mu s]$

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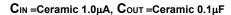
ESR vs. Output Current

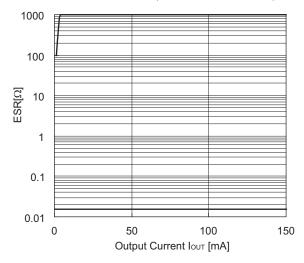
The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown above. The conditions when the white noise level is under $40\mu V$ (Avg.) are marked as the hatched area in the graph.

<Measurement conditions>

- (1) $V_{IN}=V_{OUT}+1V$
- (2) Frequency Band: 10Hz to 2MHz (BW=30Hz)
- (3) Temperature: -40°C to 85°C

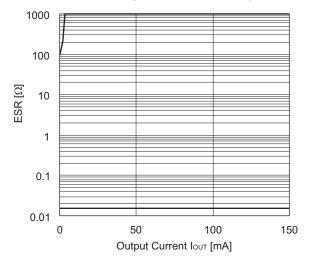
R1180x121x





R1180x281x

CIN =Ceramic 1.0μA, Cout =Ceramic 0.1μF



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 - Various Safety Devices
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 - In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.
 - 8-2. Quality Warranty Remedies
 - When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.
 - Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
 - 8-3. Remedies after Quality Warranty Period
 - With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.
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